

HIZB Andt.

M. Brunson

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PATENT

Customer No. 22,852

Attorney Docket No. 04329.2222

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Kouji MATSUO, et al.

Serial No.: 09/492,780

Filed: January 28, 2000

For: SEMICONDUCTOR DEVICE AND METHOD OF MANUFACTURING THE SAME

Assistant Commissioner for Patents
Washington, DC 20231

Sir:

AMENDMENT

In reply to the Final Office Action of May 31, 2002, and in support of the RCE filed concurrently herewith, please amend the application as follows:

IN THE CLAIMS:

Please amend claim 12 as follows:

12. (Twice Amended) A semiconductor device, comprising:

a semiconductor substrate;

a metal-containing insulating film formed directly or indirectly on said semiconductor substrate, said metal-containing insulating film including a plurality of first insulating regions each of which is formed of a grain containing a metal oxide and a second insulating region, said second insulating region formed of an amorphous insulating material; and

an electrode formed on said metal-containing insulating film.

The same

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